

VLSI Design Methodology

电子科学与技术系：陈 松

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Course Webpage:

<http://staff.ustc.edu.cn/~songch/da-ug.htm>



Outline

- Structured Design
 - Hierarchy
 - Regularity
 - Modularity
 - Locality
- Design Partitioning
- Design Methods/Styles
- Design Flow (Cell-based Design)



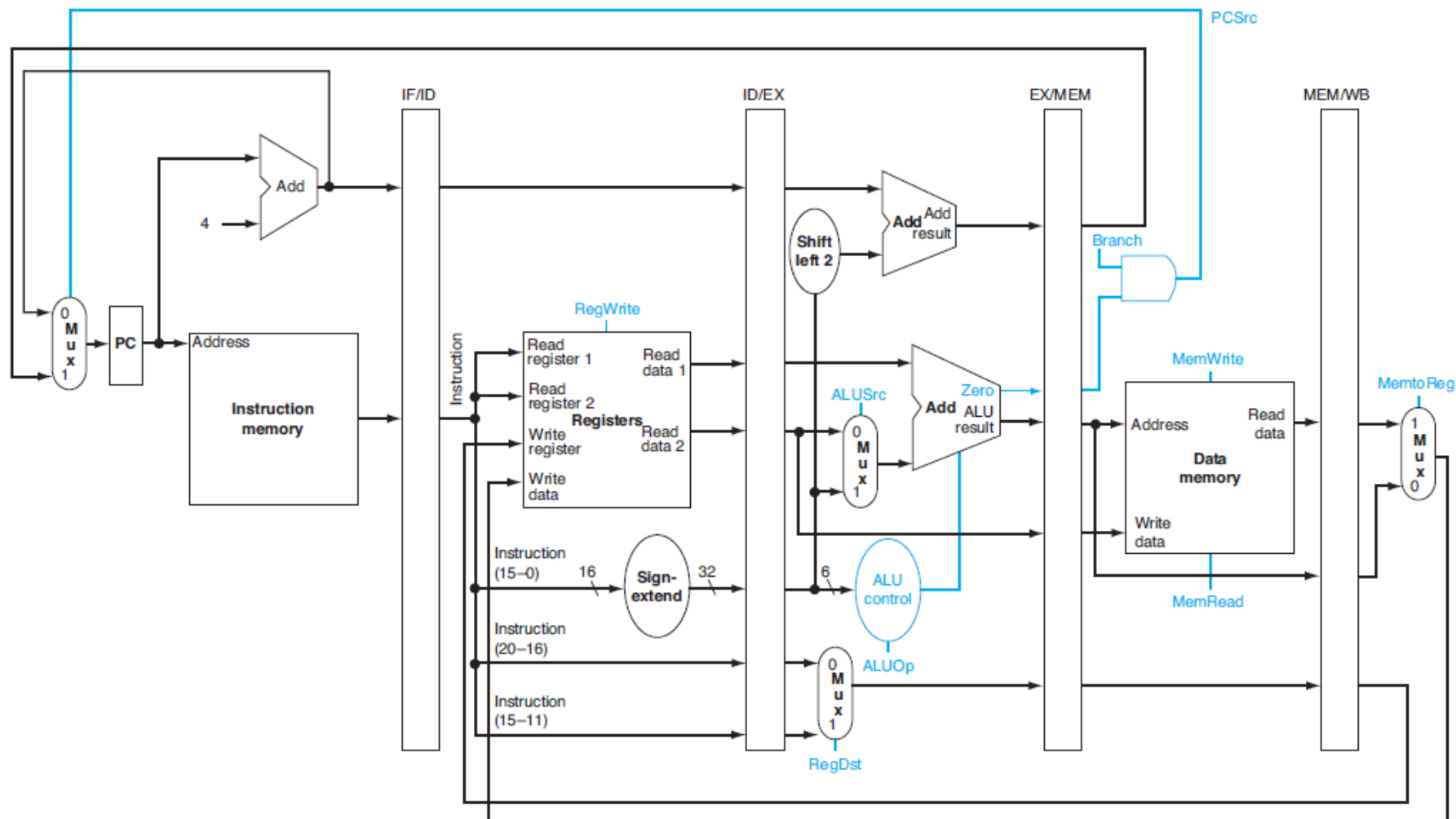
Modern VLSI Design(SoC)

- Coping with complexity
 - How to design System-on-Chips?
 - Many millions (even billions!) of transistors
 - Tens to hundreds of engineers
 - Structured Design
 - Design Partitioning
- Not designing an individual transistor



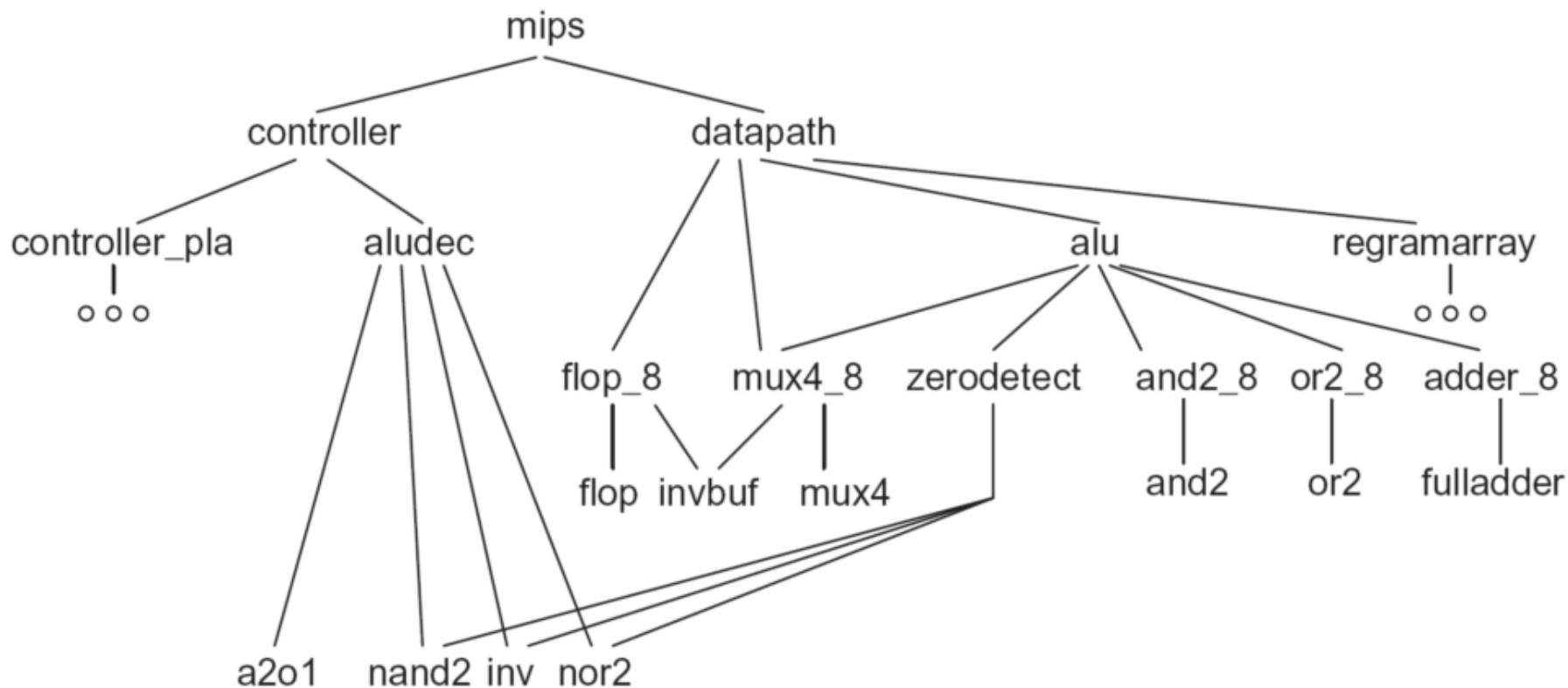


Pipelined MIPS Architecture





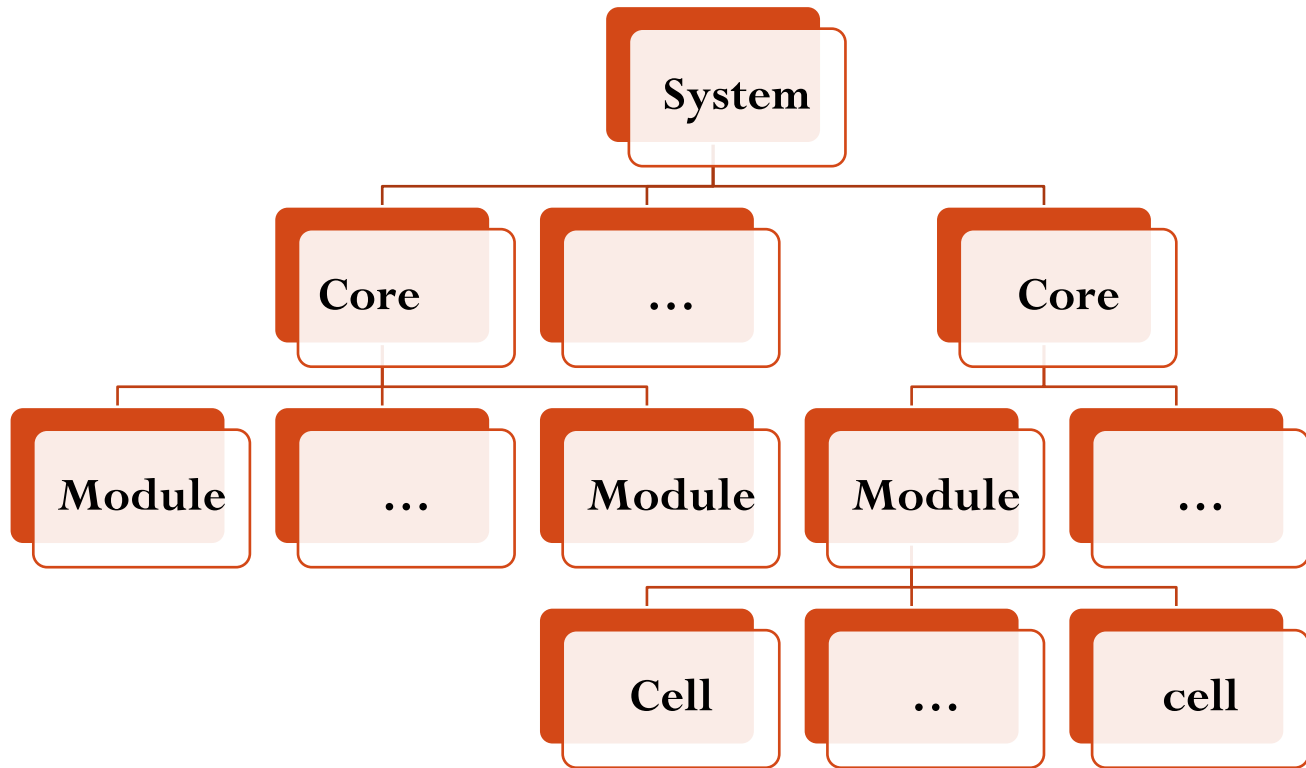
A MIPS CPU Design Hierarchy





Structured design

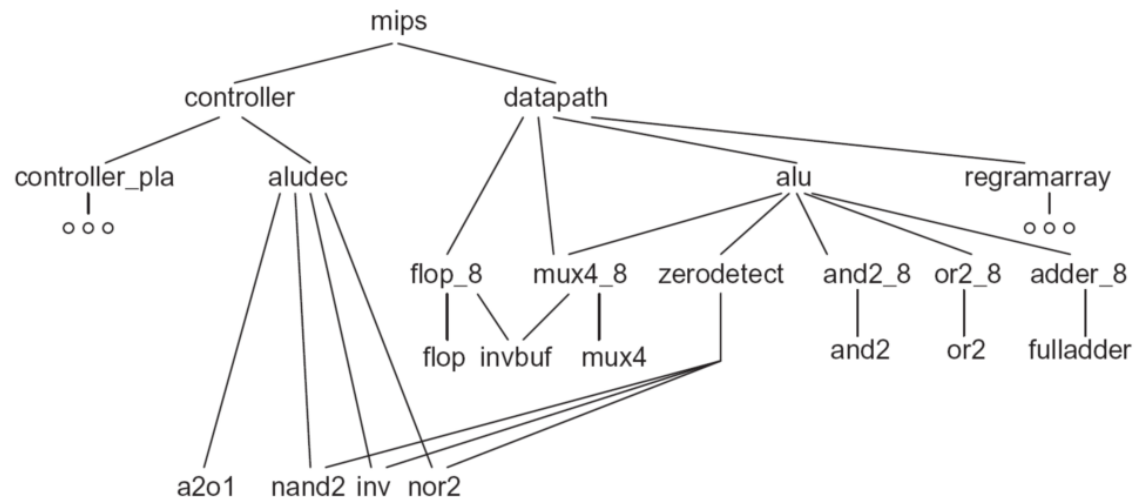
- Managing system complexity
 - Hierarchy





Structured design (Cont')

- Regularity : few modules
 - Circuit level: uniformly sized transistors
 - Gate level: a finite library of fixed-height, variable-length logic gates
 - Logic level: parameterized RAMs and ROMs
 - Architecture level: multiple identical processors





Structured design (Cont')

- Modularity: well defined modules, IP sources
 - Clear defined behavioral, structural, physical interface
 - Function
 - Name
 - Signal type
 - Electrical and Timing constraints of ports
 - Position, connection layer, wire width
- Locality
 - Local scoping: reducing the global variables
 - Temporal, Physical



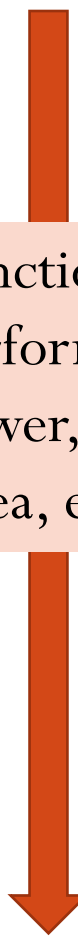
Structured design -Summary

Design Principle	Software	Hardware
Hierarchy	Subroutines, libraries	Modules
Regularity	Iteration, code sharing, object-oriented procedures	Datapaths, module reuse, regular arrays, gate arrays, standard cells
Modularity	Well-defined subroutine interface	Well-defined module interaces, timing and loading data for modules, registered inputs and outputs
Locality	Local scoping, no global variables	Local connections through floorplanning



Design Partitioning - Design Abstractions

- **Architecture:** User's perspective, what does it do?
 - Instruction set, registers, memory model
 - MIPS, x86, Alpha, PIC, ARM, ...
- **Microarchitecture**
 - Single cycle, multicycle, pipelined, superscalar?
 - 80386, 80486, Pentium, Pentium II, Pentium III, AMD Athlon, ...
- **Logic:** how are functional blocks constructed
 - Ripple carry, carry lookahead, carry select adders
- **Circuit:** how are transistors used
 - **Complementary CMOS (CMOS)**, pass transistors, domino
- **Physical:** chip layout
 - Datapaths, memories, random logic



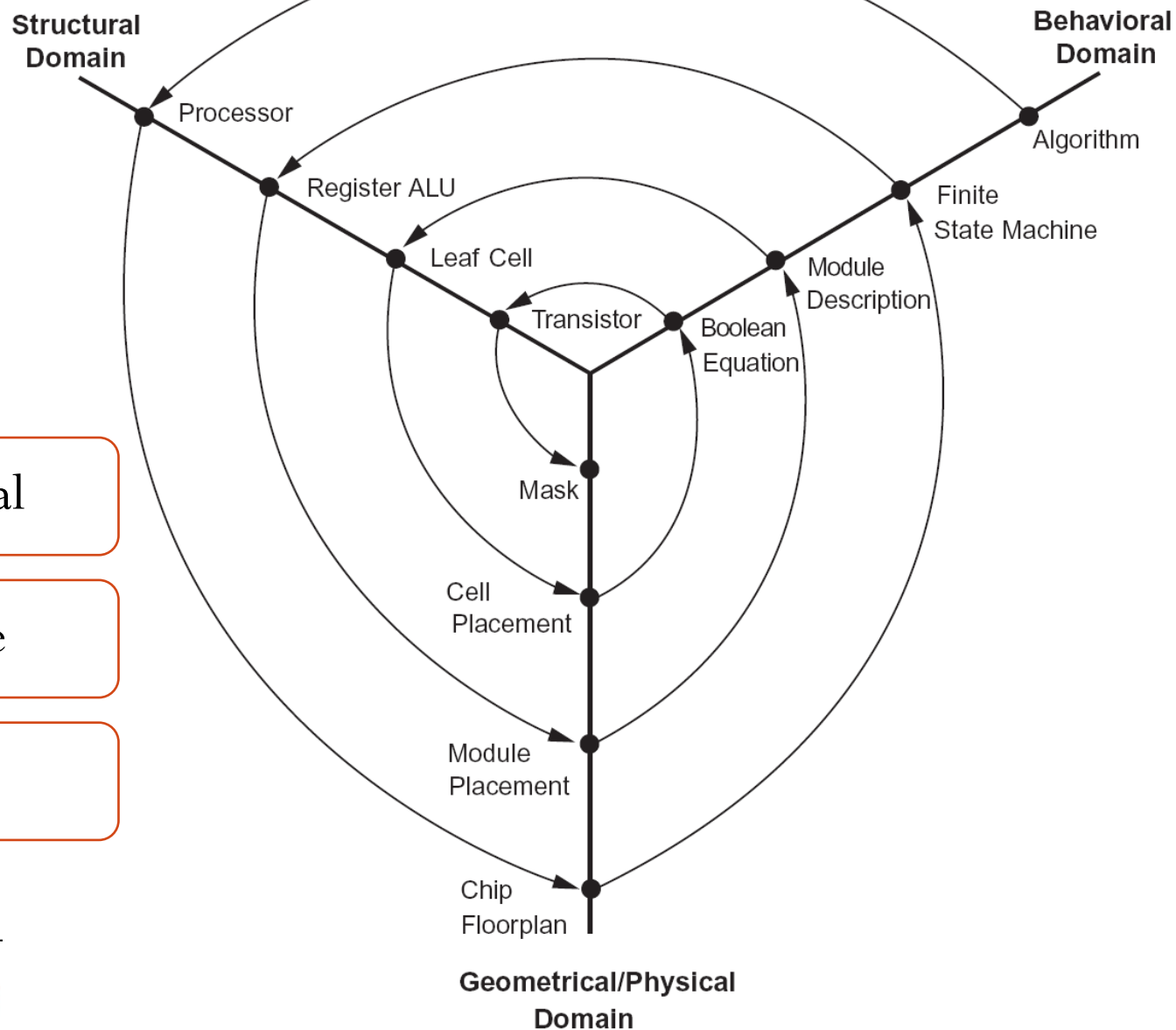
Functionality,
Performance,
Power,
Area, etc.



Design Partitioning

Design Flow:

- Behavioral
- Structure
- Physical





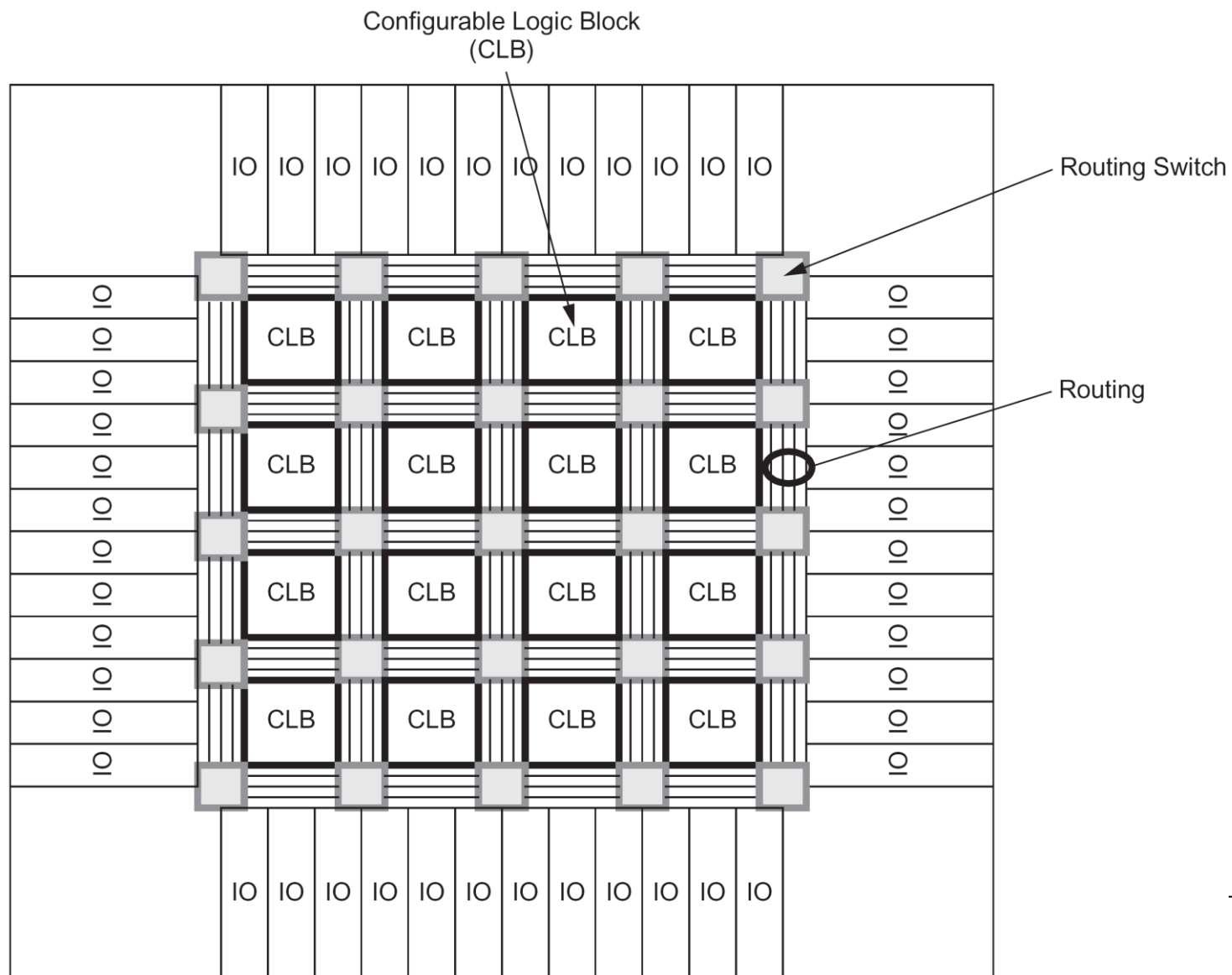
Design Methods

- Microprocessor/DSP
- Programmable Logic
 - **Programmable Logic Devices**
 - **Field-Programmable Gate Arrays (FPGAs)**
- Gate Array and Sea of Gates Design
- **Cell-Based Design**
- Full Custom Design
- *Platform-Based Design-System on a Chip*

Select the right solution: Costs, Capabilities, Limitations,

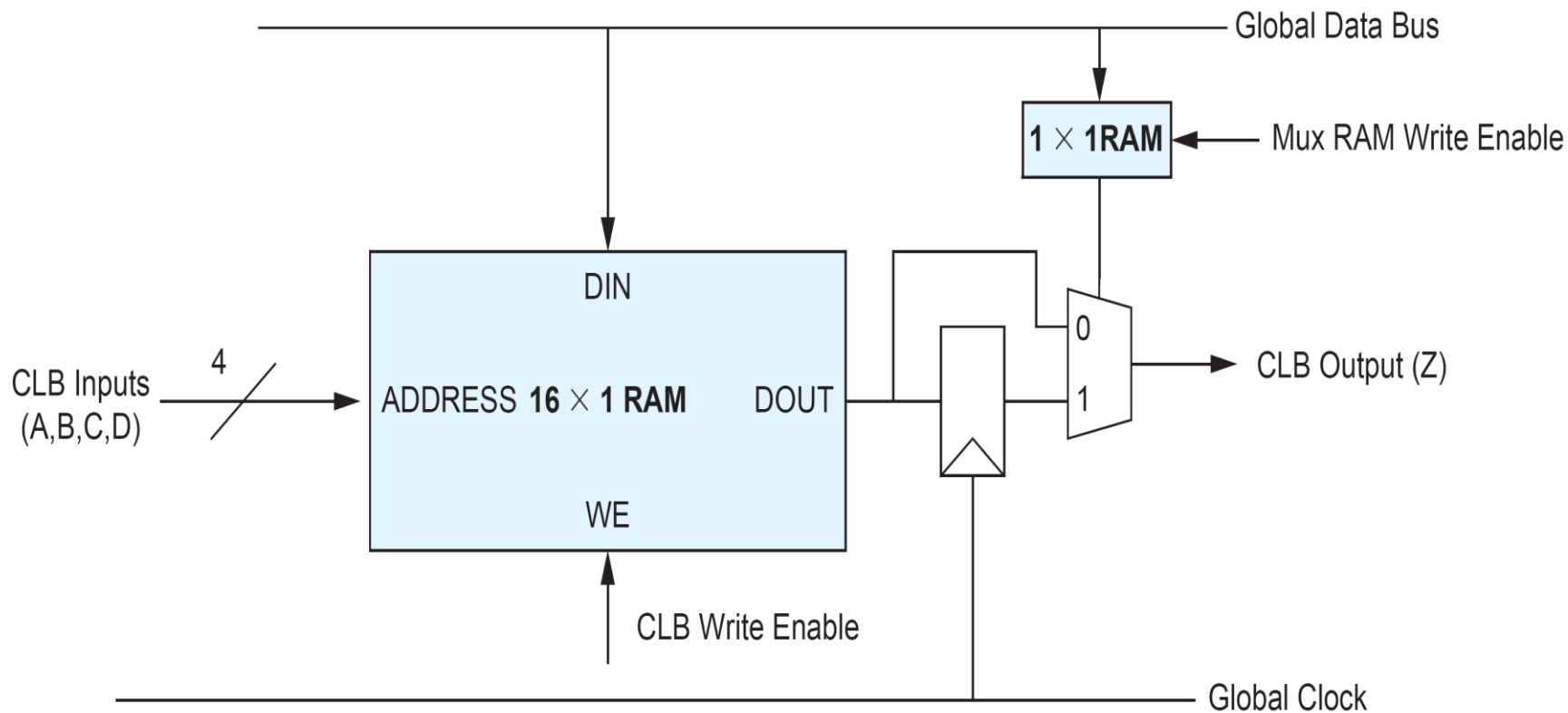


FPGA





Simple FPGA Logic Cell





RAM CLB Functions

Address	$ABCD$	$A \cdot B \cdot C \cdot D$	$\sim A$	$SUM(A,B,C)$
0	0000	0	1	0
1	1000	0	0	1
2	0100	0	1	1
3	1100	0	0	0
4	0010	0	1	1
5	1010	0	0	0
6	0110	0	1	0
7	1110	0	0	1
8	0001	0	1	0
9	1001	0	0	1
10	0101	0	1	1
11	1101	0	0	0
12	0011	0	1	1
13	1011	0	0	0
14	0111	0	1	0
15	1111	1	0	1



FPGA – A Summary

- Chip is still there
 - Millions of logic gate
 - >10GHz I/Os
- Embedded microprocessor cores and DSP accelerator hardware
- Low up-front cost and ease of correcting design errors
 - Best choice now for many low- to medium- volume custom logic applications
- Implement FPGA blocks on any CMOS chip
 - to provide programmability at the gate level



Cell-based Design

- Use a standard cell library
 - Small-scale integration logic
 - NAND, NOR, XOR, AOI, OAI, inverters, buffers, registers
 - Memories (RAM, ROM, CAM, register files)
 - System-level modules such as processors, protocol processors, serial interfaces, and bus interfaces
 - Possibility of mixed-signal and RF modules
 - Minimum Scale Integration: adders, multipliers, parity blocks

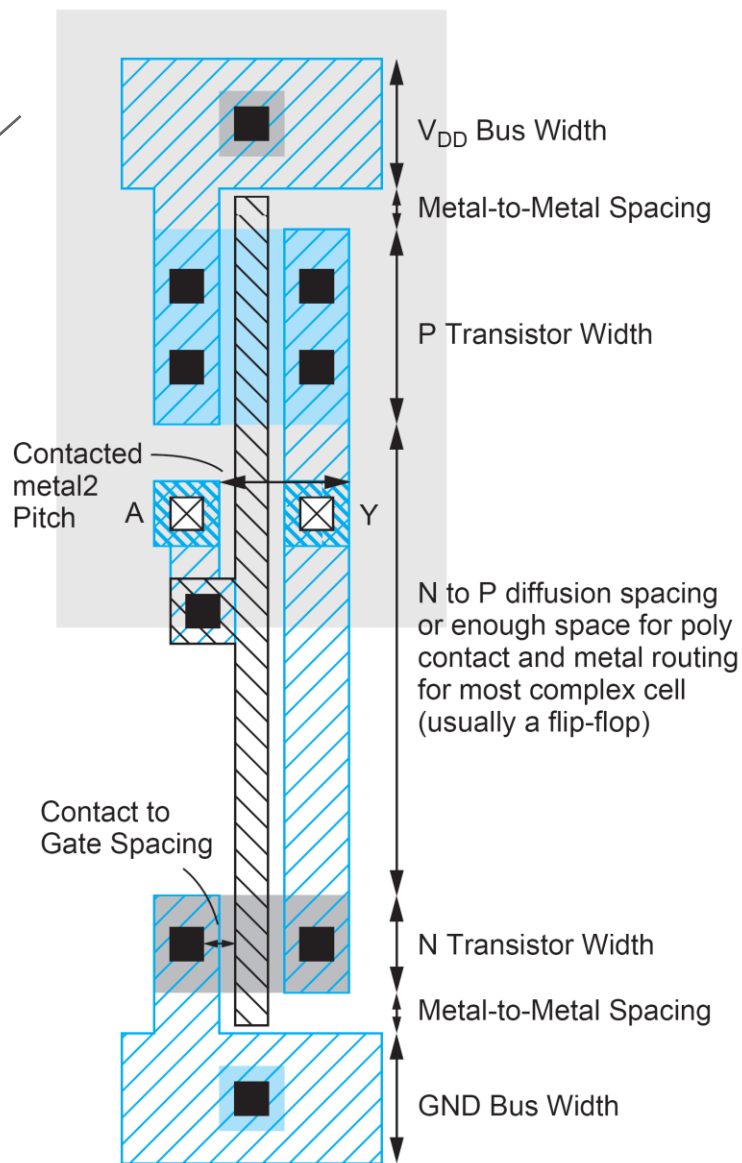
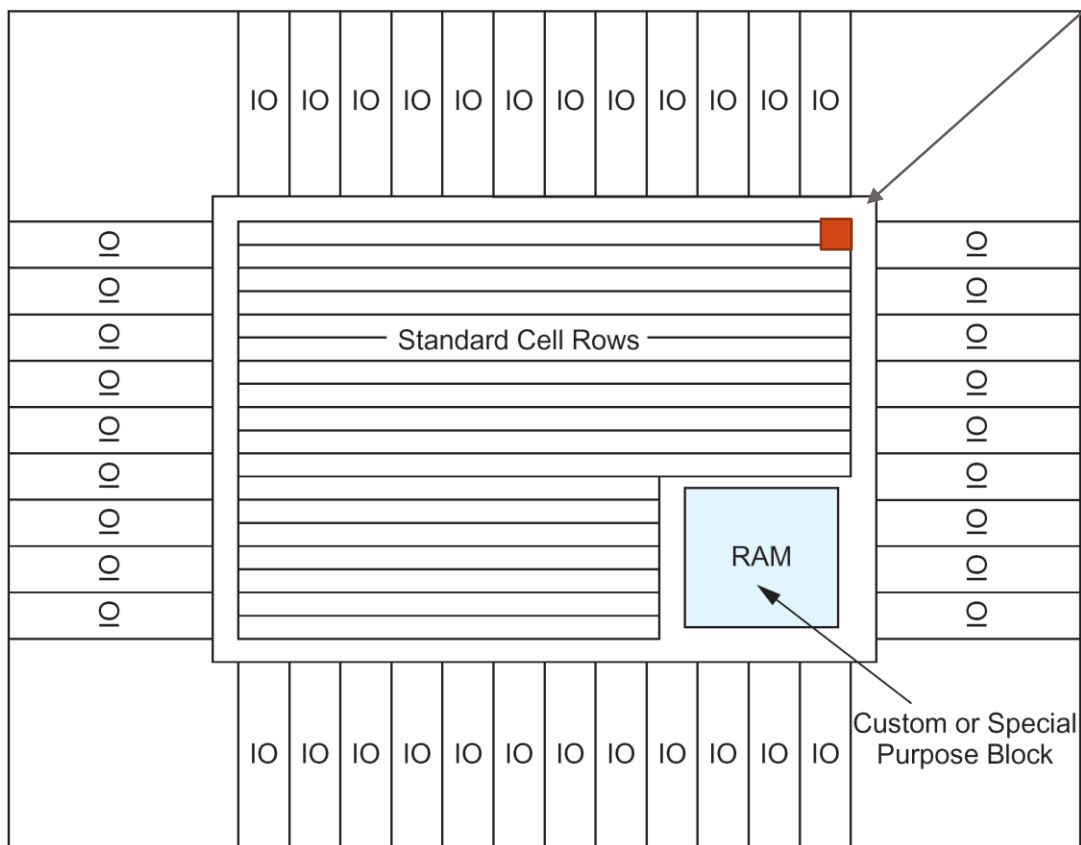


Typical Standard Cell Library

Gate Type	Variations	Options
Inverter/Buffer /Tristate Buffer		Wide range of power options, $2^{0-6} \times$ minimum size inverter
NAND/AND	2-8 inputs	High, normal, low power
NOR/OR	2-8 inputs	High, normal, low power
XOR/XNOR		High, normal, low power
AOI/OAI	21,22	High, normal, low power
Multiplexers	Inverting/noninverting	High, normal, low power
Latches		High, normal, low power
Flip-Flops	D, with and without synch/asynch set and reset, scan	High, normal, low power
I/O Pads	Input, output, tristate, bidirectional, boundary scan, slew rate limited, crystal oscillator	Various drive levels (1-16mA) and logic levels



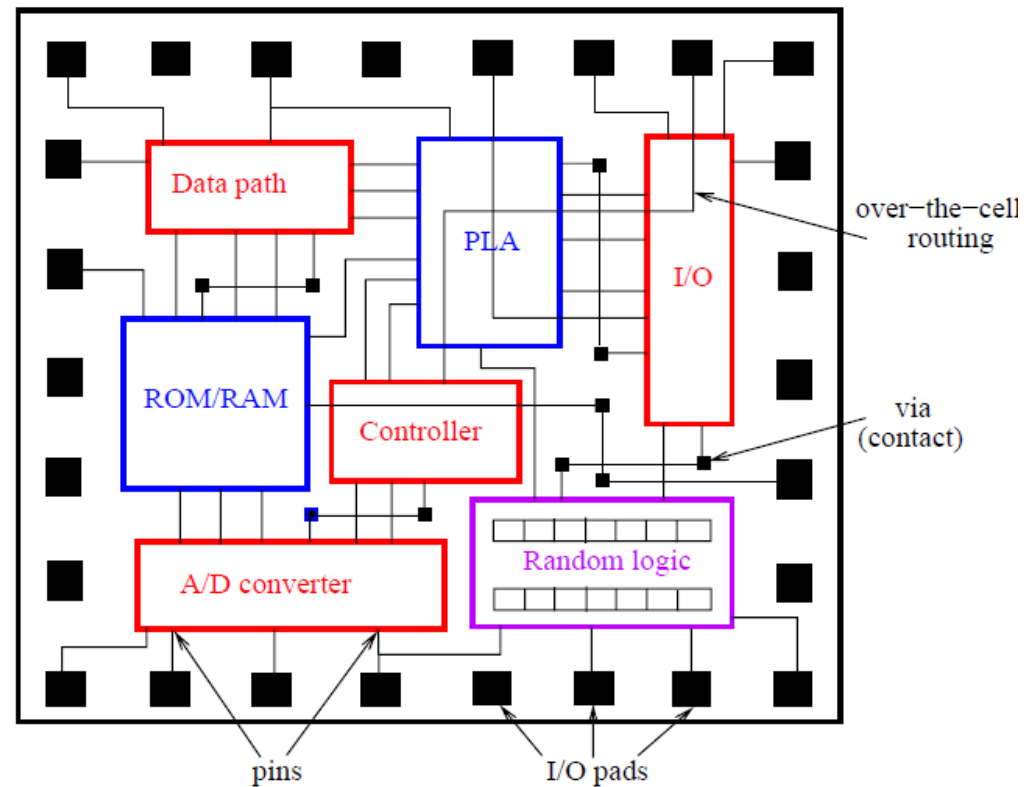
Standard cell layout





Full Custom Design

- Custom-designed microprocessors
 - >2GHz
- Synthesized ASIC
 - 200-350MHz
 - 3-7x more power
 - 2.6x if better tools and cell libraries.





Design Styles

- Custom and Semi-Custom
 - Hand-drawn transistors (+ some standard cells)
 - High volume, best possible performance: used for most advanced microprocessors
- Field-Programmable Gate Arrays
 - Transistors have been there, you configure the functions and connections
 - Prototyping
 - Low volume, low-moderate performance applications
- Standard-Cell-Based ASICs
 - High volume, moderate performance: Graphics chips, network chips, cell-phone chips



Platform-based Design – System on a Chip

- Use of predefined IP blocks has become commonplace
 - RISC processors, memory, I/O functions, common buses, NoC
 - High-level languages to program
 - Typically, a basic RISC processor, extended with multipliers, floating point units, or specialized DSP units, special hardware assisted instructions, etc.
- What you need do
 - Put the blocks together
 - Design any application-specific blocks
 - Place and route a correctly operational chip



Design Method Summary

Design Method	Non-Recurring Engineering	Unit Cost	Power Dissipation	Complexity of Implementation	Time-Market	Performance	Felxibilty
Microprocessor/DSP	Low	Medium	High	Low	Low	Low	High
PLD	Low	Medium	Medium	Low	Low	Medium	Low
FPGA	Low	Medium	Medium		Low	High	High
Cell-based	High	Low	Low	High	High	High	Low
Custom Design	High	Low	Low	High	High	Very High	Low
Platform-Based	High	Low	Low	High	High	High	Medium



ASIC (专用集成电路)

Design Automation

System/Behavioral
Descriptions

High-level Synthesis
高层次综合

Scheduling;
Binding;
Allocation.

Register Transfer Level
Descriptions

Logic Synthesis
逻辑综合

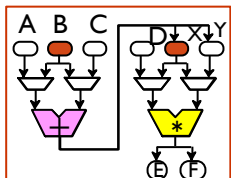
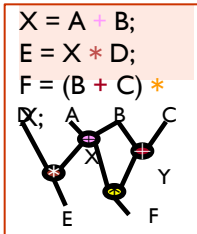
Logic
Optimization
;
Technology
Mapping.

Gate Level Netlist

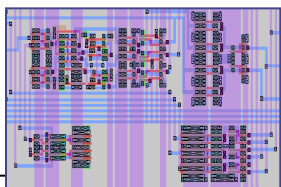
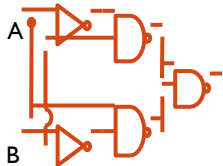
Physical Synthesis
物理综合/
芯片版图

Floorplanning;
Placement;
Routing;
etc.

Layout mask



Adder 1 Multiplier 1
Register 8 Multiplexer 4

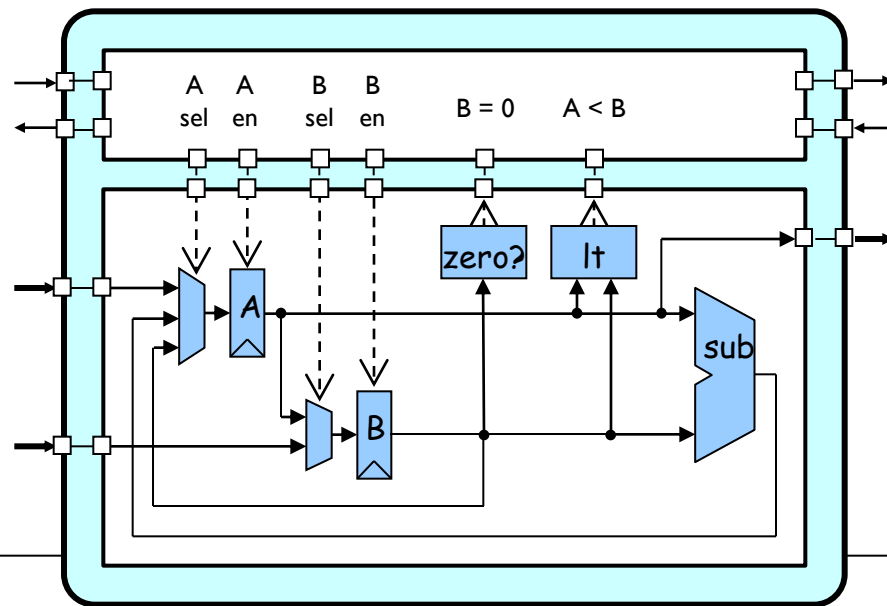




High-level Synthesis (高层次综合)

- Transformation from a behavioral specification of a system to its RTL structure specification
 - E.g., from C/C++ to RTL, Bluespec, Xilinx AutoESL
 - Promote the productivity
 - Essential tasks: scheduling, binding, allocation

```
begin
  done = 0; A = inA; B = inB;
  while ( !done )
  begin
    if ( A < B )
      swap = A;
      A = B; B = swap;
    else if ( B != 0 )
      A = A - B;
    else
      done = 1;
  end
```





Logic Synthesis (逻辑综合)

- Transformation from a Register-Transfer-Level (RTL) description to a gate-level netlists
 - Hardware Description Language
 - Verilog HDL, VHDL
 - Logic Optimization
 - Technology Mapping



Physical synthesis(物理综合)

- Transformation from a gate-level netlists to its physical layouts (masks)
 - Partitioning (划分)
 - Floorplanning (布图规划)
 - Power/Ground Network Synthesis (电源线/地线网络合成)
 - Placement (布局)
 - Routing (布线) : Clock Tree, Signal, Power/Ground
 - Post-routing (后布线优化)
 - Redundant Via Insertion (Design for Yield)

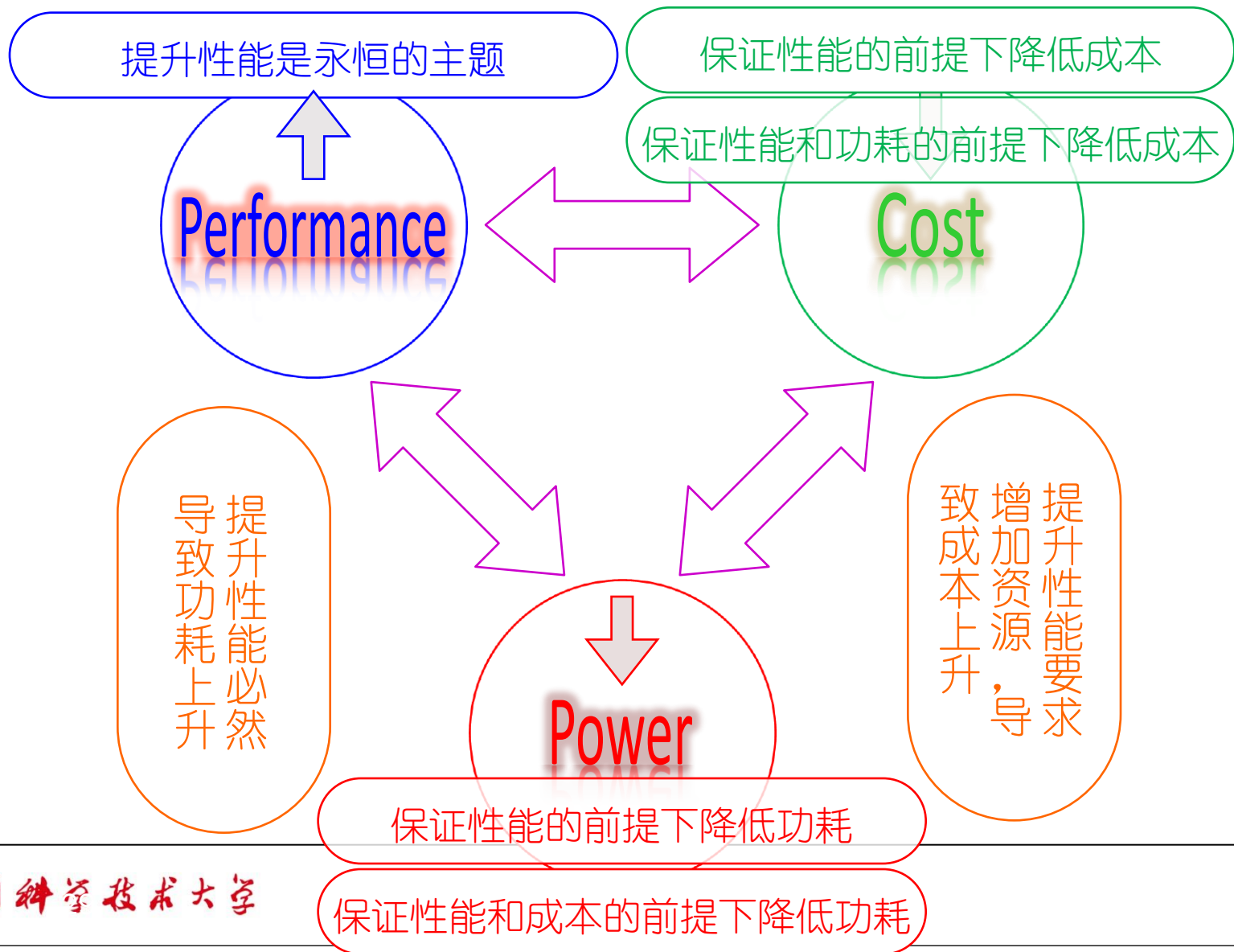
Large Scale Discrete Optimization Problems:

Computation-Consuming.

How to find good solutions in acceptable time?



Performance, Power, Cost





Modern Chip (VLSI) Design

- Managing Design Complexity (设计复杂性)
 - System-on-Chip: IP reuse, Platform-based Design Methodology
 - Electronic System Level Synthesis (High-level synthesis)
 - Raising the design abstraction
- Power (功耗)
 - Low Power Technologies: Leakage Power, Dynamic Power
 - New Device: FinFET
- Interconnect (互连)
 - Delay, System-level design & Physical Design
 - Network-on-Chip
 - 3D ICs
 - Optical-/wireless-/CNT-/RF Interconnect
- Reliability (可靠性)
- Design For Manufacturability: EUV, OPC, PSM, ...



References

- Meil H. E. Weste and David Money Narris, "CMOS VLSI Design: A circuits and Systems Perspective", fourth edition, Addison-Wesley
 - Chapter 14.
- Further reading: Chapter 14.5 Design Economics